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PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

SUBMISSION TYPE: NEW ASSIGNMENT

NATURE OF CONVEYANCE: ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SUN HO KIM	10/12/2016
JI HOON KIM	10/12/2016
HA YOUNG AHN	10/12/2016
SHANG HOON SEO	10/12/2016
SEUNG YEOP KOOK	10/12/2016
SUNG WON JEONG	10/12/2016

RECEIVING PARTY DATA

Name:	SAMSUNG ELECTRO-MECHANICS CO., LTD.	
Street Address:	treet Address: MAEYOUNG-RO 150 (MAETAN-DONG), YOUNGTONG-GU	
City:	SUWON-SI, GYEONGGI-DO	
State/Country:	KOREA, REPUBLIC OF	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16038956

CORRESPONDENCE DATA

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NAME OF SUBMITTER: RENELL FEIMSTER FOR HOSANG LEE		
SIGNATURE:	/Renell Feimster for Hosang Lee/	
ATE SIGNED: 07/19/2018		

Total Attachments: 3

PATENT REEL: 046394 FRAME: 0612

EPAS ID: PAT5057273

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PATENT REEL: 046394 FRAME: 0613

COMBINED DECLARATION AND ASSIGNMENT FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

which application is:

I believe I am the original or an original joint inventor of a claimed invention in the application for which a patent is sought on the invention entitled:

FAN-OUT SEMICONDUCTOR PACKAGE AND ELECTRONIC DEVICE INCLUDING THE SAME

X	attached, or
	United States application number or PCT international application number filed on
The	above-identified application was made or authorized to be made by me.
exec requ Cust	e event that the filing date and/or application number are not entered above at the time ute this document, and if such information is deemed necessary, I hereby authorize and est the registered practitioners of McDermott Will & Emery LLP, associated with the omer Number 20277, to insert above the filing date and/or application number of the ication.
	eby acknowledge that any willful false statement made in this declaration is punishable at 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

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ASSIGNMENT

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I hereby assign to

SAMSUNG ELECTRO-MECHANICS CO., LTD.

having an address at Macyoung-Ro 150 (Mactan-Dong), Youngtong-Gu, Suwon-Si, Gyconggi-Do, Republic of Korca

hereinafter designated as the Assignee, the entire (100%) right, title and interest for the United States as defined in 35 USC §100, in the invention described in the application identified in this document.

I hereby confirm any prior assignment to Assignee, and to the extent that I have not already done so, agree to assign, and hereby do, sell, assign and transfer unto Assignee and its successors in interest, the full and exclusive right, title and interest in the United States of America and throughout the world, including the right to claim priority under the laws of the United States, the Paris Convention, and any foreign countries, to the inventions as described in the aforesaid application, to the aforesaid application itself, and all divisions, continuations, continuations-in-part, or other applications claiming priority directly or indirectly from the aforesaid application, and any United States or foreign Letters Patent, utility model, or other similar rights which may be granted thereon, including reissues, reexaminations and extensions thereof, and all copyright rights throughout the world in the aforesaid application and the subject matter disclosed therein, these rights, title and interest to be held and enjoyed by Assignee to the full end of the term for which the Letters Patent, utility model, or other similar rights, are granted and any extensions thereof as fully and entirely as the same would have been held by the undersigned had this assignment and sale not been made, and the right to sue for, and recover for past infringements of, or liabilities for, any of the rights relating to any of the applications, patents, utility models, or other similar rights, resulting therefrom, and the copyright rights;

I hereby covenant and agree to execute all instruments or documents required or requested for the making and prosecution of any applications of any type for patent, utility model, or other similar rights, and for copyright, in the United States and in all foreign countries including, but not limited to, any provisional, continuation, continuation-in-part, divisional, renewal or substitute thereof, and as to letters patent any reissue, re-examination, or extension thereof, and for litigation regarding, or for the purpose of protecting title and to the said invention, the United States application for patent, or Letters Patent therefor, and to testify in support thereof, for the benefit of Assignee without further or other compensation than that above set forth;

I hereby covenant that no assignment, sale, license, agreement or encumbrance has been or will be entered into which would conflict with this Assignment.

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egal name of first inventor Sun Ho KIM	Date.
est inventor's signature	October 12, 2016
egal name of second inventor It Hoon KIM	
It HOOR KITM	Date
김 2\ 3	October 12, 2016
Legal name of thus inventor Ha Young AHN	Date
Third inventor's signature	October 12, 2016
Legal name of fourth inventor	
Shang Hoon SEO	Date
Fourth inventor's signature	October 12, 2016
Legal name of fifth inventor	
Seung Yeop KOOK	Date
The third inventor of the transfer of the tran	October 12, 2016
Legal name of sixth inventor Sung Won JEONG	
Sting won redired	Date

October 12, 2016

REEL: 046394 FRAME: 0616